

# **STF7N80K5**, **STFI7N80K5**

# N-channel 800 V, 0.95 Ω typ., 6 A MDmesh™ K5 Power MOSFETs in TO-220FP and I²PAKFP packages

Datasheet - production data

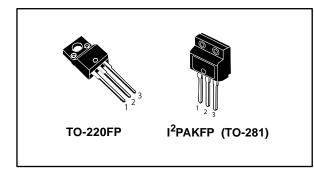
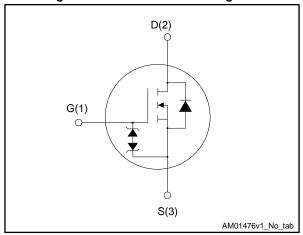


Figure 1: Internal schematic diagram



## **Features**

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	ΙD	Ртот
STF7N80K5	800 V	120	6 A	25 W
STFI7N80K5	800 V	1.2 12	бА	25 VV

- Industry's lowest R<sub>DS(on)</sub> x area
- Industry's best FoM (figure of merit)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

### **Applications**

Switching applications

## **Description**

These very high voltage N-channel Power MOSFETs are designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STF7N80K5	7N90VE	TO-220FP	Tubo
STFI7N80K5	7N80K5	I <sup>2</sup> PAKFP (TO-281)	Tube

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# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	±30	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	6	Α
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 100 °C	3.8	Α
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	24	Α
P <sub>TOT</sub>	Total dissipation at $T_C = 25$ °C	25	W
dv/dt (3)	Peak diode recovery voltage slope	4.5	\ //
dv/dt (4)	MOSFET dv/dt ruggedness	50	V/ns
Viso	Insulation withstand voltage (RMS) from all three leads to external heat sink (t=1 s; $T_{\text{C}}$ = 25 °C)	2500	V
Tj	Operating junction temperature range	55 to 150	°C
T <sub>stg</sub>	Storage temperature range	- 55 to 150	

#### Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	5	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient	62.5	°C/W

**Table 4: Avalanche characteristics** 

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetitive or not repetitive (pulse width limited by T <sub>jmax</sub> )	2	Α
Eas	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$ , $V_{DD} = 50$ V)	88	mJ

<sup>&</sup>lt;sup>(1)</sup>Limited by package.

<sup>&</sup>lt;sup>(2)</sup>Pulse width limited by safe operating area

 $<sup>^{(3)}</sup>I_{SD} \le 6$  A, di/dt  $\le 100$  A/ $\mu$ s,  $V_{DS(peak)} \le V_{(BR)DSS}$ 

 $<sup>^{(4)}</sup>V_{DS} \le 640 \ V$ 

## 2 Electrical characteristics

T<sub>C</sub> = 25 °C unless otherwise specified

Table 5: On/off-state

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA	800			V
	7	$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$			1	μΑ
I <sub>DSS</sub>	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$ $T_{C} = 125 ^{\circ}\text{C}$ (1)			50	μΑ
Igss	Gate body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±10	μΑ
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DD} = V_{GS}$ , $I_D = 100 \mu A$	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3 A		0.95	1.2	Ω

#### Notes:

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	360	1	pF
Coss	Output capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$	-	30	-	pF
Crss	Reverse transfer capacitance	V <sub>es</sub> = 0 V	-	1	1	pF
C <sub>o(tr)</sub> <sup>(1)</sup>	Equivalent capacitance time related	V <sub>DS</sub> = 0 to 640 V, V <sub>GS</sub> = 0 V	-	47	ı	pf
C <sub>o(er)</sub> <sup>(2)</sup>	Equivalent capacitance energy related	VDS = 0 10 040 V, VGS = 0 V	-	20	ı	pf
Rg	Intrinsic gate resistance	f = 1 MHz, I <sub>D</sub> =0 A	-	6	-	Ω
Qg	Total gate charge	$V_{DD} = 640 \text{ V}, I_D = 6 \text{ A}$	-	13.4	ı	nC
Qgs	Gate-source charge	V <sub>GS</sub> = 0 to 10 V	-	3.7	ı	nC
Q <sub>gd</sub>	Gate-drain charge	(see Figure 16: "Test circuit for gate charge behavior")	-	7.5		nC

#### Notes:

<sup>&</sup>lt;sup>(1)</sup>Defined by design, not subject to production test.

 $<sup>^{(1)}</sup>$ Co<sub>(tr)</sub> is a constant capacitance value that gives the same charging time as Coss while Vps is rising from 0 to 80% Vpss

 $<sup>^{(2)}</sup>$ Co<sub>(er)</sub> is a constant capacitance value that gives the same stored energy as Coss while VDs is rising from 0 to 80% VDss.

**Table 7: Switching times** 

<b>3</b> · · · · · · · · · · · · · · · · · · ·						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	V <sub>DD</sub> = 400 V, I <sub>D</sub> = 3 A,	-	11.3	-	ns
tr	Rise time	$R_G = 4.7 \Omega$	ı	8.3	-	ns
t <sub>d(off)</sub>	Turn-off delay time	V <sub>GS</sub> = 10 V (see <i>Figure 15: "Test circuit</i>	-	23.7	-	ns
t <sub>f</sub>	Fall time	for resistive load switching times" and Figure 20: "Switching time waveform")	-	20.2	-	ns

#### Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		6	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		24	А
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 6 A, V <sub>GS</sub> = 0 V	-		1.5	V
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 6 \text{ A, di/dt} = 100$	-	315		ns
Qrr	Reverrse recovery charge	A/μs,V <sub>DD</sub> = 60 V (see <i>Figure 17: "Test circuit</i>	-	2.8		μC
I <sub>RRM</sub>	Reverse recovery current	for inductive load switching and diode recovery times")	ı	17.5		Α
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 6 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s,}$	-	480		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, T_j = 150 \text{ °C}$ (see Figure 17: "Test circuit	-	3.8		μC
I <sub>RRM</sub>	Reverse recovery current	for inductive load switching and diode recovery times")	-	16		А

#### Notes:

Table 9: Gate-source Zener diode

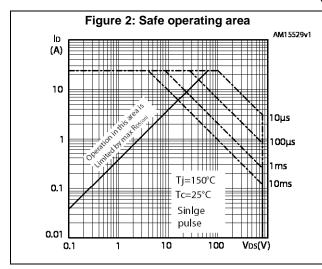
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)</sub> GSO	Gate-source breakdown voltage	I <sub>GS</sub> = ±1 mA, I <sub>D</sub> = 0 A	±30	-	-	٧

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

<sup>&</sup>lt;sup>(1)</sup>Pulse width limited by safe operating area

 $<sup>^{(2)}</sup>$ Pulsed: pulse duration = 300  $\mu$ s, duty cycle 1.5%

# 2.1 Electrical characteristics (curves)



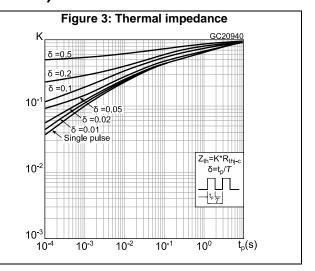


Figure 4: Output characteristics

AM15531v1

(A)

10

VGS=10V

9V

8

4

2

0

4

2

0

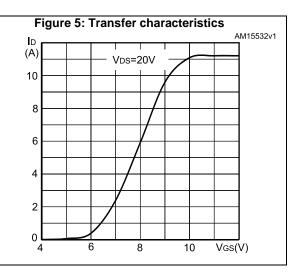
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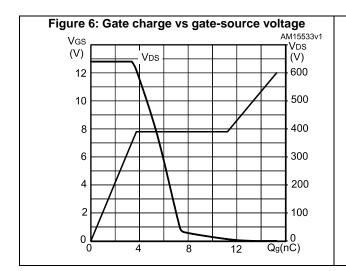
8

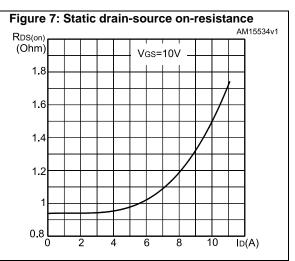
12

16

VDS(V)







57

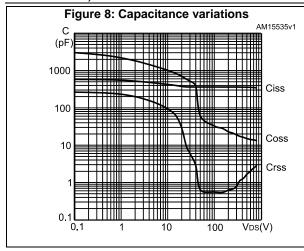


Figure 9: Output capacitance stored energy

Eoss
(µJ)

6

4

2

0

200

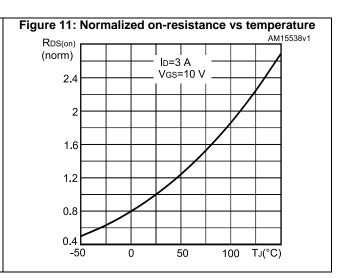
400

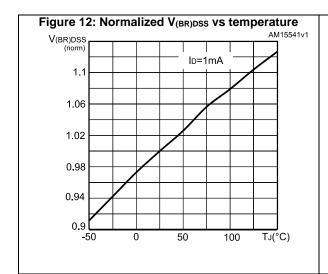
600

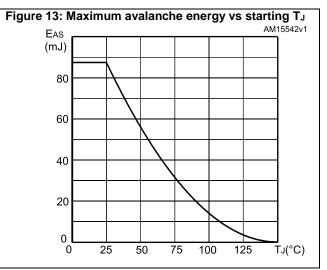
800 VDS(V)

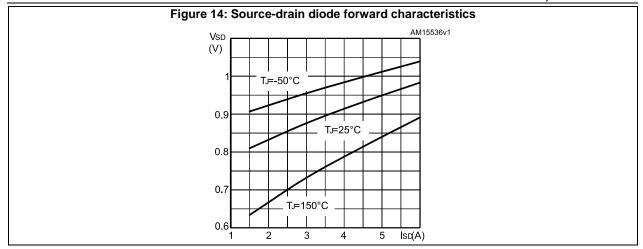
Figure 10: Normalized gate threshold voltage vs temperature

VGS(th)
(norm)
1.1
1
0.9
0.8
0.7
0.6
-50
0
50
100
TJ(°C)









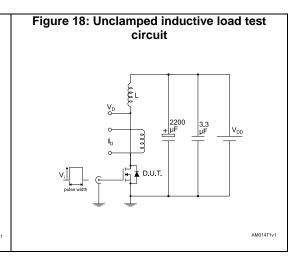
## 3 Test circuits

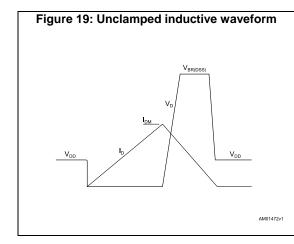
Figure 15: Test circuit for resistive load switching times

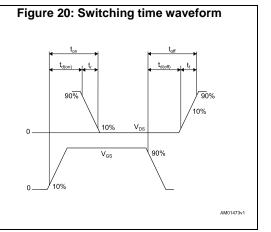
Figure 16: Test circuit for gate charge behavior

12 V 47 KΩ 100 nF 100

Figure 17: Test circuit for inductive load switching and diode recovery times







## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

# 4.1 TO-220FP package information

Figure 21: TO-220FP package outline

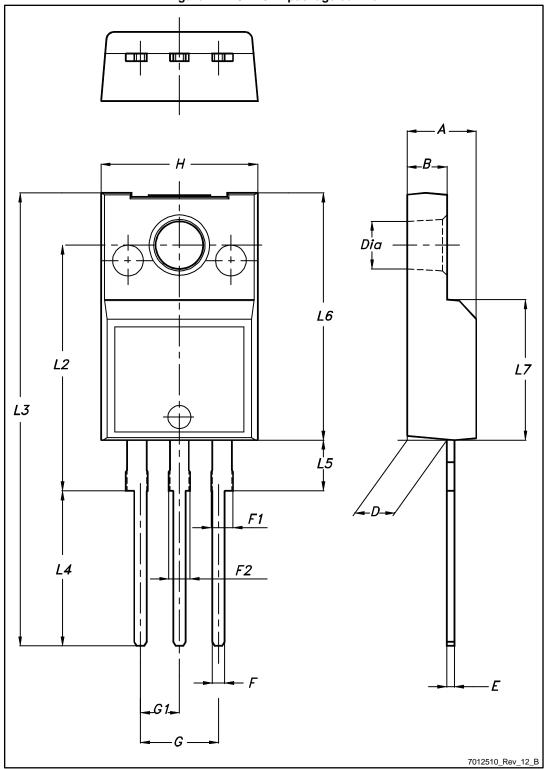


Table 10: TO-220FP package mechanical data

Table 10. 10-2201 P package mechanical data					
Dim.		mm			
Dilli.	Min.	Тур.	Max.		
А	4.4		4.6		
В	2.5		2.7		
D	2.5		2.75		
Е	0.45		0.7		
F	0.75		1		
F1	1.15		1.70		
F2	1.15		1.70		
G	4.95		5.2		
G1	2.4		2.7		
Н	10		10.4		
L2		16			
L3	28.6		30.6		
L4	9.8		10.6		
L5	2.9		3.6		
L6	15.9		16.4		
L7	9		9.3		
Dia	3		3.2		

# 4.2 I<sup>2</sup>PAKFP (TO-281) package information

Figure 22: I<sup>2</sup>PAKFP (TO-281) package outline

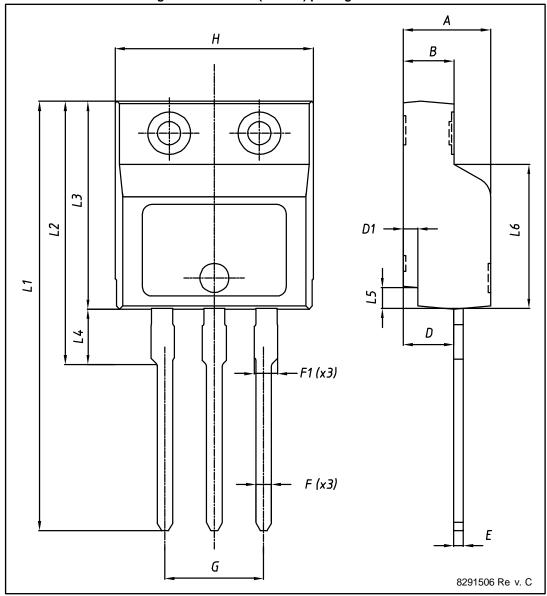


Table 11: I<sup>2</sup>PAKFP (TO-281) mechanical data

Dim.	mm		
	Min.	Тур.	Max.
А	4.40		4.60
В	2.50		2.70
D	2.50		2.75
D1	0.65		0.85
Е	0.45		0.70
F	0.75		1.00
F1			1.20
G	4.95		5.20
Н	10.00		10.40
L1	21.00		23.00
L2	13.20		14.10
L3	10.55		10.85
L4	2.70		3.20
L5	0.85		1.25
L6	7.50	7.60	7.70

# 5 Revision history

Table 12: Document revision history

Date	Revision	Changes	
11-Oct-2013	1	First release. Part numbers previously included in datasheet DocID023448	
05-Jul-2017	2	Modified features on cover page.  Modified Table 2: "Absolute maximum ratings", Table 7: "Switching times" and Table 9: "Gate-source Zener diode".  Minor text changes.	

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